

30V P-Channel MOSFET

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
-30V	190mΩ@-10V	-1.9A
	330mΩ@-4.5V	

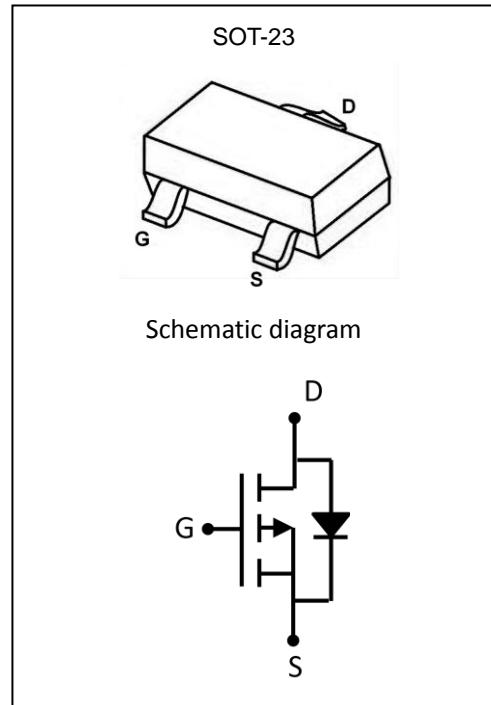
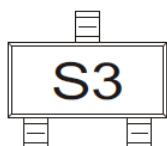
Feature

- TrenchFET Power MOSFET
- Excellent $R_{DS(on)}$ and Low Gate Charge
- AEC-Q101 qualified (Automotive grade with suffix "Q".)
- Expsemi electronics

Application

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Switch

MARKING:



ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	-1.9	A
Power Dissipation	P_D	0.35	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	357	°C/W
Junction Temperature	T_J	150	°C
Storage Temperature	T_{STG}	-55~+150	°C

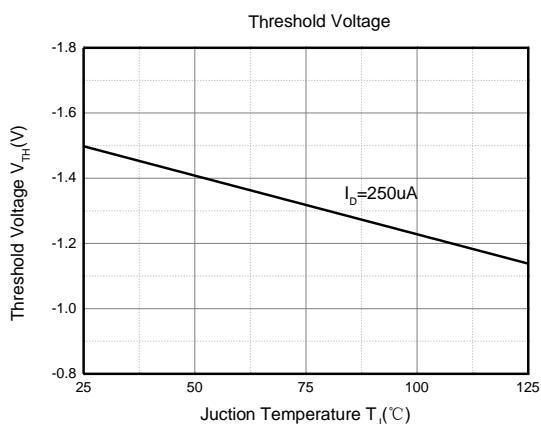
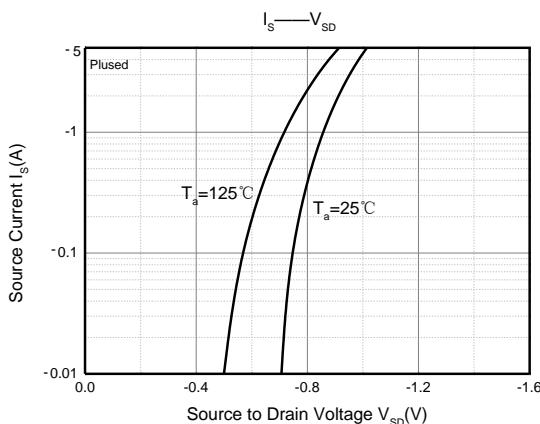
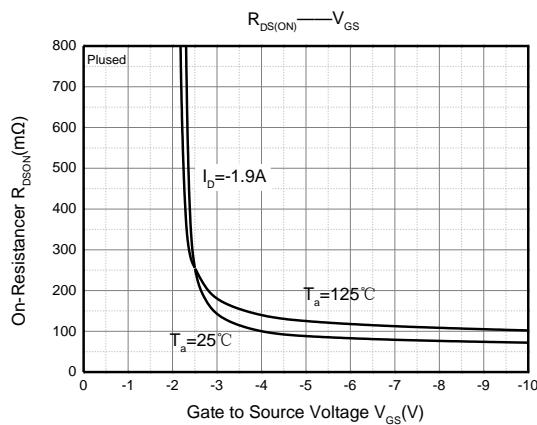
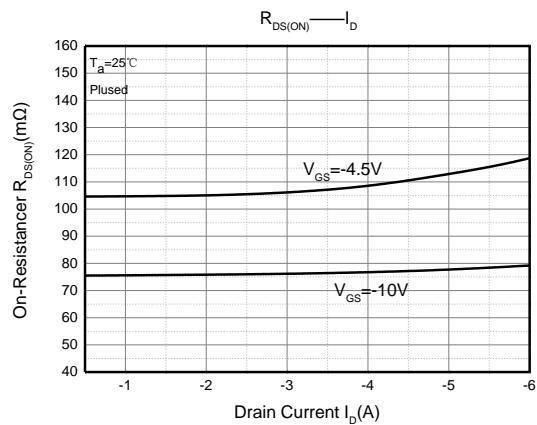
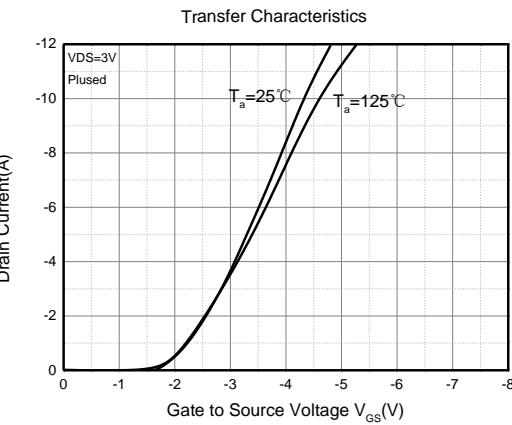
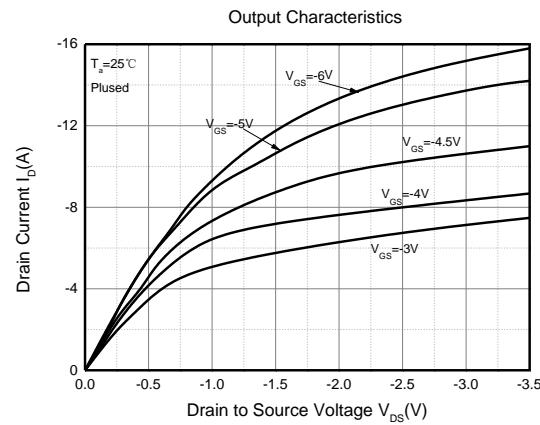
MOSFET ELECTRICAL CHARACTERISTICS($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-30			V
Zero gate voltage drain current	I_{DSS}	$V_{\text{DS}} = -30\text{V}, V_{\text{GS}} = 0\text{V}$			-1	μA
Gate-body leakage current	I_{GSS}	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			± 100	nA
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-1	-1.5	-3	V
Drain-source on-resistance ¹	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -10\text{V}, I_D = -1.9\text{A}$		75	190	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}, I_D = -1.4\text{A}$		105	330	
Forward transconductance ¹	g_{FS}	$V_{\text{DS}} = -5\text{V}, I_D = -1.9\text{A}$	1	4.6		S
Dynamic characteristics²						
Input Capacitance	C_{iss}	$V_{\text{DS}} = -15\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		154		pF
Output Capacitance	C_{oss}			34		
Reverse Transfer Capacitance	C_{rss}			22		
Total Gate Charge	Q_g	$V_{\text{DS}} = -15\text{V}, V_{\text{GS}} = -4.5\text{V}, I_D = -1.9\text{A}$		2.5		nC
Gate-Source Charge	Q_{gs}			0.65		
Gate-Drain Charge	Q_{gd}			.2		
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -15\text{V}, V_{\text{GEN}} = -10\text{V}, I_D = -1.5\text{A}$ $R_L = 10\Omega, R_{\text{GEN}} = 1\Omega$		4.5		ns
Turn-on rise time	t_r			11.5		
Turn-off delay time	$t_{\text{d}(\text{off})}$			12		
Turn-off fall time	t_f			8.5		
Source-Drain Diode characteristics						
Diode forward current	I_s	$T_C = 25^\circ\text{C}$			-1.9	A
Diode pulsed forward current ¹	I_{SM}				-5.7	A
Diode Forward voltage	V_{DS}	$V_{\text{GS}} = 0\text{V}, I_s = -1.5\text{A}$		-0.85	-1.2	V

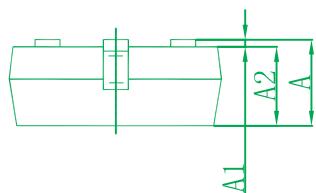
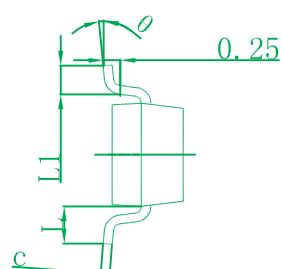
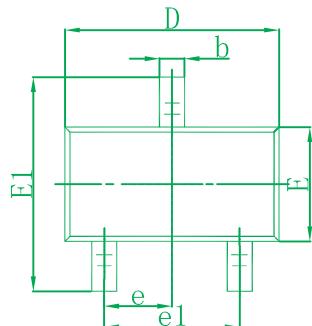
Notes:

1. Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
2. Guaranteed by design, not subject to production testing.

Typical Electrical and Thermal Characteristics

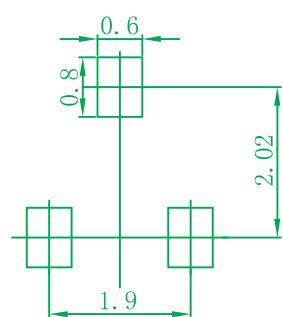


SOT-23 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.150	0.035	0.045
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.050	0.110	0.120
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.360 REF		0.014 REF	
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.

Ordering information

Device	Package	Shipping
EP2303	SOT-23	3000/Tape&Reel(7inches)